March 1999



FDC6305N

Dual N-Channel 2.5V Specified PowerTrench[™] MOSFET

General Description

These N-Channel low threshold 2.5V specified MOSFETs are produced using Fairchild Semiconductor's advanced PowerTrench process that has been especially tailored to minimize on-state resistance and yet maintain low gate charge for superior switching performance.

Applications

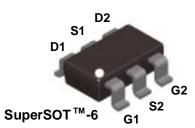
- Load switch
- DC/DC converter
- Motor driving

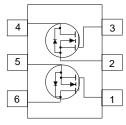
Features

• 2.7 A, 20 V.
$$R_{DS(ON)} = 0.08 \ \Omega @ V_{GS} = 4.5 \ V$$

 $R_{\rm DS(ON)} = 0.12 \ \Omega \ @ V_{\rm GS} = 2.5 \ V$

- Low gate charge (3.5nC typical).
- Fast switching speed.
- High performance trench technology for extremely low $\rm R_{\rm DS(ON)}.$
- SuperSOTTM-6 package: small footprint (72% smaller than standard SO-8); low profile (1mm thick).





Absolute Maximum Ratings T_A = 25°C unless otherwise noted

Symbol	Parameter		Ratings	Units
V _{DSS}	Drain-Source Voltage		20	V
V _{GSS}	Gate-Source Voltage		<u>+</u> 8	V
ID	Drain Current - Continuous	(Note 1a)	2.7	А
	- Pulsed		8	
PD	Power Dissipation for Single Operation	(Note 1a)	0.96	W
		(Note 1b)	0.9	
		(Note 1c)	0.7	
T _J , T _{stg}	Operating and Storage Junction Temperature Range		-55 to +150	۰C
Therma	I Characteristics			
R _{θJA}	Thermal Resistance, Junction-to-Ambient	(Note 1a)	130	∘C/W
R _θ JC	Thermal Resistance, Junction-to-Case	(Note 1)	60	°C/W

Package Outlines and Ordering Information

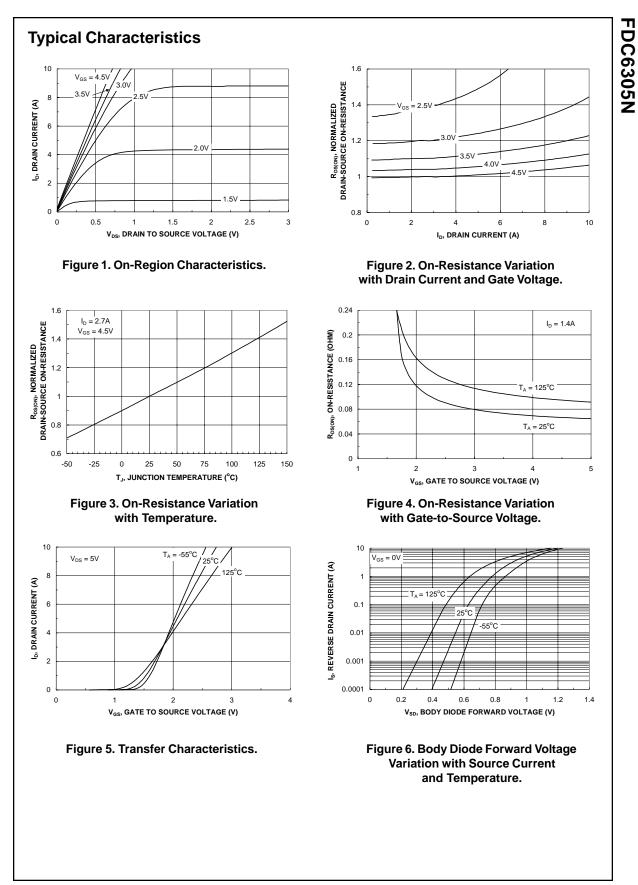
_	Device Marking	Device	Reel Size	Tape Width	Quantity
	.305	FDC6305N	7"	8mm	3000 units

©1999 Fairchild Semiconductor Corporation

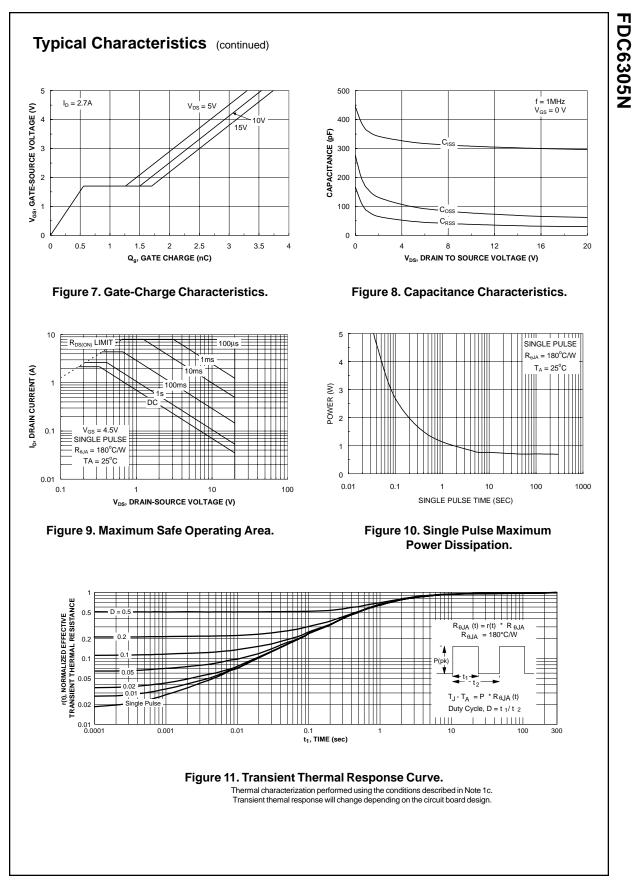
teristics ain-Source Breakdown Voltage eakdown Voltage Temperature befficient ro Gate Voltage Drain Current ate-Body Leakage Current, Forward	$V_{GS} = 0 \text{ V}, \text{ I}_{D} = 250 \mu\text{A}$ $I_{D} = 250 \mu\text{A}, \text{ Referenced to } 25^{\circ}\text{C}$ $V_{DS} = 16 \text{ V}, V_{GS} = 0 \text{ V}$	20	14		V mV/°C
eakdown Voltage Temperature befficient ro Gate Voltage Drain Current ate-Body Leakage Current, Forward	$I_D = 250 \ \mu\text{A}, \ \text{Referenced to} \ 25^\circ\text{C}$ $V_{DS} = 16 \ \text{V}, \ V_{GS} = 0 \ \text{V}$	20	14		
befficient ro Gate Voltage Drain Current ate-Body Leakage Current, Forward	V _{DS} = 16 V, V _{GS} = 0 V		14		mV/∘C
ate-Body Leakage Current, Forward					
				1	μA
	$V_{GS} = 8 V, V_{DS} = 0 V$			100	nA
ate-Body Leakage Current, Reverse	V_{GS} = -8 V, V_{DS} = 0 V			-100	nA
eristics (Note 2)					
ate Threshold Voltage	$V_{DS} = V_{GS}, I_{D} = 250 \mu A$	0.4	0.9	1.5	V
ate Threshold Voltage	$I_D = 250 \ \mu$ A, Referenced to 25° C		-2.7		mV/∘C
atic Drain-Source I-Resistance	$V_{GS} = 4.5, I_D = 2.7 \text{ A}$ $V_{GS} = 4.5 I_D = 2.7 \text{ A}, T_J = 125^{\circ}\text{C}$ $V_{CS} = 2.5 \text{ V}, I_D = 2.2 \text{ A}$		0.060 0.095 0.085	0.080 0.128 0.120	Ω
n-State Drain Current	$V_{GS} = 4.5 \text{ V}, V_{DS} = 5 \text{ V}$	6			А
rward Transconductance	$V_{DS} = 5 V, I_{D} = 2.7 A$		8		S
haractoristics	•				
	$V_{DS} = 10 \text{ V}, V_{GS} = 0 \text{ V},$		310		pF
	f = 1.0 MHz				pF
	1		40		pF
•					
	$V_{DD} = 10 V I_D = 1 A$	1	5	15	ns
,	$V_{GS} = 4.5 \text{ V}, \text{ R}_{GEN} = 6 \Omega$				ns
	-				ns
	-				ns
	$V_{DS} = 10 V. I_{D} = 2.7 A.$		-	-	nC
5	$V_{GS} = 4.5 V$				nC
•	-				nC
		1		0.8	А
ain-Source Diode Forward Voltage	$V_{GS} = 0 \text{ V}, \text{ I}_{S} = 0.8 \text{ A}$ (Note 2)		0.77	1.2	V
	Atte Threshold Voltage Atte Drain-Source Atter Source Atter International Content Atter	ate Threshold Voltage $V_{DS} = V_{GS}$, $I_D = 250 \ \mu A$ ate Threshold Voltage mperature Coefficient $I_D = 250 \ \mu A$, Referenced to $25^{\circ}C$ atic Drain-Source $V_{GS} = 4.5$, $I_D = 2.7$ A $I_{-Resistance}$ $V_{GS} = 4.5$, $I_D = 2.7$ A, $T_J = 125^{\circ}C$ $V_{GS} = 2.5$ V, $I_D = 2.2$ A $I_{-State Drain Current}$ $V_{GS} = 4.5$ V, $V_{DS} = 5$ V $I_{-State Drain Current}$ $V_{DS} = 5$ V, $V_{DS} = 5$ V $I_{-State Drain Current}$ $V_{DS} = 5$ V, $I_D = 2.7$ A $I_{-State Drain Current}$ $V_{DS} = 10$ V, $V_{DS} = 5$ V $I_{-State Drain Current}$ $V_{DS} = 10$ V, $V_{GS} = 0$ V, $I_{-State Drain Current}$ $V_{DS} = 10$ V, $V_{GS} = 0$ V, $I_{-State Drain Current}$ $V_{DS} = 10$ V, $V_{CS} = 0$ V, $I_{-Tot Capacitance}$ $V_{DD} = 10$ V, $I_D = 1$ A, $I_{-Tot On Delay Time}$ $V_{DD} = 10$ V, $I_D = 1$ A, $I_{-On Rise Time}$ $V_{DS} = 10$ V, $I_D = 1$ A, $I_{-On Rise Time}$ $V_{DS} = 10$ V, $I_D = 2.7$ A, $I_{-On Rise Time}$ $V_{DS} = 10$ V, $I_D = 1$ A, $I_{-On Rise Time}$ $V_{DS} = 10$ V, $I_D = 1$ A, $I_{-On Rise Time}$ $V_{DS} = 10$ V, $I_D = 2.7$ A, $I_{-S} = 4.5$ V, $I_{-S} = 10$ V, $I_{-S} = 2.7$ A, $I_{-S} = 4.5$ V, $I_{-S} = 10$ V, $I_{-S} = 2.7$ A, $I_{-S} = 4.5$ V $I_{-S} = 4.5$ V	Atte Threshold Voltage $V_{DS} = V_{GS}, I_D = 250 \ \mu A$ 0.4Atte Threshold Voltage mperature Coefficient $I_D = 250 \ \mu A$, Referenced to $25^{\circ}C$ 0.4Atte Threshold Voltage mperature Coefficient $I_D = 250 \ \mu A$, Referenced to $25^{\circ}C$ 0.4Atte Threshold Voltage mperature Coefficient $V_{GS} = 4.5, I_D = 2.7 \ A$ 0.4Atter Source $V_{GS} = 4.5 \ I_D = 2.7 \ A$ $V_{GS} = 4.5 \ V, D_D = 2.2 \ A$ 0.4Atter State Drain Current $V_{GS} = 4.5 \ V, D_D = 5 \ V$ 6rward Transconductance $V_{DS} = 5 \ V, I_D = 2.7 \ A$ 6but Capacitance $V_{DS} = 5 \ V, I_D = 2.7 \ A$ 6but Capacitance $V_{DS} = 5 \ V, I_D = 2.7 \ A$ 6but Capacitance $V_{DS} = 10 \ V, V_{GS} = 0 \ V, f = 1.0 \ MHz$ 6characteristics(Note 2)1000000000000000000000000000000000000	Atter Threshold Voltage $V_{DS} = V_{GS}, I_D = 250 \ \mu\text{A}$ 0.40.9Atter Threshold Voltage mperature Coefficient $I_D = 250 \ \mu\text{A}, \text{Referenced to } 25^{\circ}\text{C}$ -2.7Atter Threshold Voltage mperature Coefficient $V_{GS} = 4.5, I_D = 2.7 \ \text{A}, T_J = 125^{\circ}\text{C}$ 0.060Atter Threshold Voltage meaning the period of the peri	the Threshold Voltage $V_{DS} = V_{GS}$, $I_D = 250 \ \mu A$ 0.4 0.9 1.5 atte Threshold Voltage $I_D = 250 \ \mu A$, Referenced to 25° C -2.7 mperature Coefficient $V_{GS} = 4.5$, $I_D = 2.7 \ A$, $T_J = 125^{\circ}$ C 0.060 0.080 -Resistance $V_{GS} = 4.5$, $I_D = 2.7 \ A$, $T_J = 125^{\circ}$ C 0.085 0.128 N-Resistance $V_{GS} = 4.5$ V, $V_{DS} = 5$ V 6 0.085 0.120 N-State Drain Current $V_{GS} = 4.5$ V, $V_{DS} = 5$ V 6 0.085 0.120 n-State Drain Current $V_{GS} = 5$ V, $I_D = 2.7 \ A$ 8 0.085 0.120 n-ward Transconductance $V_{DS} = 5$ V, $I_D = 2.7 \ A$ 8 0 0.085 0.120 nearcteristics $V_{DS} = 10 \ V, V_{SS} = 0 \ V,$ 310 1

2. Pulse Test: Pulse Width \leq 300 $\mu s,$ Duty Cycle \leq 2.0%

FDC6305N



FDC6305N, Rev. C



FDC6305N, Rev. C

FAIRCHILD

TRADEMARKS

The following are registered and unregistered trademarks Fairchild Semiconductor owns or is authorized to use and is not intended to be an exhaustive list of all such trademarks.

ACEx™
CoolFET™
CROSSVOLT™
E ² CMOS [™]
FACT™
FACT Quiet Series™
FAST [®]
FASTr™
GTO™
HiSeC™

ISOPLANAR[™] MICROWIRE[™] POP[™] PowerTrench[®] QFET[™] QS[™] Quiet Series[™] SuperSOT[™]-3 SuperSOT[™]-6 SuperSOT[™]-8

TinyLogic™ UHC™ VCX™

DISCLAIMER

FAIRCHILD SEMICONDUCTOR RESERVES THE RIGHT TO MAKE CHANGES WITHOUT FURTHER NOTICE TO ANY PRODUCTS HEREIN TO IMPROVE RELIABILITY, FUNCTION OR DESIGN. FAIRCHILD DOES NOT ASSUME ANY LIABILITY ARISING OUT OF THE APPLICATION OR USE OF ANY PRODUCT OR CIRCUIT DESCRIBED HEREIN; NEITHER DOES IT CONVEY ANY LICENSE UNDER ITS PATENT RIGHTS, NOR THE RIGHTS OF OTHERS.

LIFE SUPPORT POLICY

FAIRCHILD'S PRODUCTS ARE NOT AUTHORIZED FOR USE AS CRITICAL COMPONENTS IN LIFE SUPPORT DEVICES OR SYSTEMS WITHOUT THE EXPRESS WRITTEN APPROVAL OF FAIRCHILD SEMICONDUCTOR CORPORATION. As used herein:

1. Life support devices or systems are devices or systems which, (a) are intended for surgical implant into the body, or (b) support or sustain life, or (c) whose failure to perform when properly used in accordance with instructions for use provided in the labeling, can be reasonably expected to result in significant injury to the user. 2. A critical component is any component of a life support device or system whose failure to perform can be reasonably expected to cause the failure of the life support device or system, or to affect its safety or effectiveness.

PRODUCT STATUS DEFINITIONS

Definition of Terms

Datasheet Identification	Product Status	Definition
Advance Information	Formative or In Design	This datasheet contains the design specifications for product development. Specifications may change in any manner without notice.
Preliminary	First Production	This datasheet contains preliminary data, and supplementary data will be published at a later date. Fairchild Semiconductor reserves the right to make changes at any time without notice in order to improve design.
No Identification Needed	Full Production	This datasheet contains final specifications. Fairchild Semiconductor reserves the right to make changes at any time without notice in order to improve design.
Obsolete	Not In Production	This datasheet contains specifications on a product that has been discontinued by Fairchild semiconductor. The datasheet is printed for reference information only.

www.fairchildsemi.com